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August 2016

Single-Channel: 6N138M, 6N139M Dual-Channel: HCPL2730M, HCPL2731M 8-Pin DIP Low Input Current High Gain Split Darlington Optocouplers

#### **Features**

- Low Current 0.5 mA
- Superior CTR 2000%
- Superior CMR 10 kV/µs
- CTR Guaranteed 0 to 70°C
- Dual Channel HCPL2730M, HCPL2731M
- · Safety and Regulatory Approvals
  - UL1577, 5,000 VAC<sub>RMS</sub> for 1 Minute
  - DIN EN/IEC60747-5-5

### **Applications**

- · Digital Logic Ground Isolation
- · Telephone Ring Detector
- · EIA-RS-232C Line Receiver
- High Common Mode Noise Line Receiver
- μP Bus Isolation
- Current Loop Receiver

### **Description**

The single-channel, 6N138M, 6N139M and dual-channel HCPL2730M, HCPL2731M optocouplers consist of an AlGaAs LED optically coupled to a high gain split darlington photodetector.

The split darlington configuration separating the input photodiode and the first stage gain from the output transistor permits lower output saturation voltage and higher speed operation than possible with conventional darlington phototransistor optocoupler. In the dual channel devices, HCPL2730M and HCPL2731M, an integrated emitter-base resistor provides superior stability over temperature.

The combination of a very low input current of 0.5 mA and a high current transfer ratio of 2000% makes this family particularly useful for input interface to MOS, CMOS, LSTTL and EIA RS232C, while output compatibility is ensured to CMOS as well as high fan-out TTL requirements. An internal noise shield provides exceptional common mode rejection of 10 kV/µs.

### **Related Resources**

- www.fairchildsemi.com/products/optoelectronics/
- www.fairchildsemi.com/pf/HC/HCPL0700.html
- www.fairchildsemi.com/pf/HC/HCPL0730.html
- www.fairchildsemi.com/pf/HC/HCPL0731.html

### **Schematics**

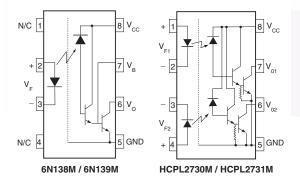


Figure 1. Schematics

### **Package Outlines**

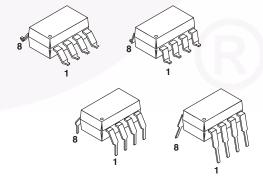


Figure 2. Package Options

# **Safety and Insulation Ratings**

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter	Parameter		
	< 150 V <sub>RMS</sub>	I–IV	
Latella Cara Charlis and a DINLYDE	< 300 V <sub>RMS</sub>	I–IV	
Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage	< 450 V <sub>RMS</sub>	I–III	
The first table 1,1 of fraction walls voltage	< 600 V <sub>RMS</sub>	I–III	
	< 1,000 V <sub>RMS</sub> (Option T, TS)	I-III	
Climatic Classification		40/100/21	
Pollution Degree (DIN VDE 0110/1.89)		2	
Comparative Tracking Index		175	

Symbol	Parameter	Value	Unit
V	Input-to-Output Test Voltage, Method A, $V_{IORM}$ x 1.6 = $V_{PR}$ , Type and Sample Test with $t_m$ = 10 s, Partial Discharge < 5 pC	2,262	V <sub>peak</sub>
V <sub>PR</sub>	Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC	2,651	V <sub>peak</sub>
$V_{IORM}$	Maximum Working Insulation Voltage	1,414	$V_{peak}$
$V_{IOTM}$	Highest Allowable Over-Voltage	6,000	$V_{peak}$
	External Creepage	≥ 8.0	mm
	External Clearance	≥ 7.4	mm
	External Clearance (for Option TV, 0.4" Lead Spacing)	≥ 10.16	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.5	mm
T <sub>S</sub>	Case Temperature <sup>(1)</sup>	150	°C
I <sub>S,INPUT</sub>	Input Current <sup>(1)</sup>	200	mA
P <sub>S,OUTPUT</sub>	Output Power (Duty Factor ≤ 2.7%) <sup>(1)</sup>	300	mW
R <sub>IO</sub>	Insulation Resistance at T <sub>S</sub> , V <sub>IO</sub> = 500 V <sup>(1)</sup>	> 10 <sup>9</sup>	Ω

### Note:

1. Safety limit value - maximum values allowed in the event of a failure.

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.  $T_A = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Value	Unit
T <sub>STG</sub>	Storage Temperature	-40 to +125	°C
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
$T_J$	Junction Temperature	-40 to +125	°C
T <sub>SOL</sub>	Lead Solder Temperature	260 for 10 sec	°C

Symbol	Parameter	Device	Value	Unit	
EMITTER					
I <sub>F</sub> (avg)	DC/Average Forward Input Current Per Channel	All	20	mA	
I <sub>F</sub> (pk)	Peak Forward Input Current Per Channel (50% duty cycle, 1 ms P.W.)	All	40	mA	
I <sub>F</sub> (trans)	Peak Transient Input Current Per Channel (≤ 1 µs P.W., 300 pps)	All	1	Α	
$V_{R}$	Reverse Input Voltage Per Channel	All	5	V	
$P_{D}$	Input Power Dissipation Per Channel <sup>(2)</sup>	All	35	mW	
DETECTOR					
I <sub>O</sub> (avg)	Average Output Current Per Channel	All	60	mA	
V <sub>ER</sub>	Emitter-Base Reverse Voltage	6N138M, 6N139M	0.5	V	
	Supply Voltage Output Voltage	6N138M, HCPL2730M	-0.5 to 7.0	V	
$V_{CC}, V_{O}$	Supply Voltage, Output Voltage	6N139M, HCPL2731M	-0.5 to 18.0	V	
Po	Output Power Dissipation Per Channel	All	100	mW	

#### Note

2. No derating required for devices operated within the T<sub>OPR</sub> specification (6N138M and 6N139M only).

### **Electrical Characteristics**

### **Individual Component Characteristics**

( $V_{CC}$  = 5.0 V,  $T_A$  = 0°C to 70°C unless otherwise specified. Typical value is measured at  $T_A$  = 25°C.)

Symbol	Parameter	Device	Test Conditions	Min.	Тур.	Max.	Unit
EMITTER				•			
V <sub>F</sub>	Input Forward Voltage	All	I <sub>F</sub> = 1.6 mA, T <sub>A</sub> = 25°C		1.30	1.70	V
٧F	input i orward voltage	All	I <sub>F</sub> = 1.6 mA			1.75	V
$BV_R$	Input Reverse Breakdown Voltage	All	I <sub>R</sub> = 10 μA, T <sub>A</sub> = 25°C	5.0	19.0		V
$\Delta V_F / \Delta T_A$	Temperature Coefficient of Forward Voltage	All	I <sub>F</sub> = 1.6 mA		-1.94		mV/°C
DETECTO	R						
	Logic Low Supply	6N138M, 6N139M	$I_F$ = 1.6 mA, $V_O$ = Open, $V_{CC}$ = 18 V		0.4	1.5	A
I <sub>CCL</sub>	Current	HCPL2730M	$V_{CC} = 7 \text{ V}$ $I_{F1} = I_{F2} = 1.6 \text{ mA},$		1.25	3	mA
			$V_{CC} = 18 \text{ V}  V_{O1} = V_{O2} = \text{Open}$		1.25	3	
	Logic High Supply	6N138M, 6N139M	$I_F = 0$ mA, $V_O = Open$ , $V_{CC} = 18$ V		0.0003	10	
Іссн	Current		$V_{CC} = 7 \text{ V}$ $I_{F1} = I_{F2} = 0 \text{ mA},$		0.0003	20	μA
		HCPL2731M	V <sub>CC</sub> = 18 V V <sub>O1</sub> = V <sub>O2</sub> = Open		0.0003	20	

### **Transfer Characteristics**

Symbol	Parameter	Device	Test Conditions	Min.	Тур.	Max.	Unit
COUPLED							
		6N138M	I <sub>F</sub> = 1.6 mA, V <sub>O</sub> = 0.4 V,	300	1600		
		HCPL2730M	V <sub>CC</sub> = 4.5 V	300	2400		
CTR	Current Transfer	6N139M	$I_F = 0.5 \text{ mA}, V_O = 0.4 \text{ V},$	400	2000		%
CIK	Ratio <sup>(3)(4)</sup>	HCPL2731M	V <sub>CC</sub> = 4.5 V	400	3500		/0
		6N139M	I <sub>F</sub> = 1.6 mA, V <sub>O</sub> = 0.4 V,	500	1600		
		HCPL2731M	V <sub>CC</sub> = 4.5 V	300	2400		
		6N138M	I <sub>E</sub> = 0 mA, V <sub>O</sub> = V <sub>CC</sub> = 7 V		0.001	250	
la	I <sub>OH</sub> Logic High Output Current	HCPL2730M	1 - 0 111A, VO - VCC - 7 V		0.001	250	μA
'OН		6N139M	$I_{\rm F} = 0 \text{ mA}, V_{\rm O} = V_{\rm CC} = 18 \text{ V}$		0.0036	100	μ, τ
		HCPL2731M	1 = 0 110 t, v0 = vcc = 10 v			100	
		6N138M	I <sub>F</sub> = 1.6 mA, I <sub>O</sub> = 4.8 mA,		0.06	0.4	
		HCPL2730M	V <sub>CC</sub> = 4.5 V		0.05	0.4	
		6N139M	$I_F = 0.5 \text{ mA}, I_O = 2 \text{ mA},$ $V_{CC} = 4.5 \text{ V}$		0.05	0.4	
	Logic Low Output Volt-	6N139M	I <sub>F</sub> = 1.6 mA, I <sub>O</sub> = 8 mA,	0.093	0.4	.,	
V <sub>OL</sub>	age <sup>(4)</sup>	HCPL2731M	V <sub>CC</sub> = 4.5 V		0.08	0.4	V
		6N139M	I <sub>F</sub> = 5 mA, I <sub>O</sub> = 15 mA,		0.13	0.4	
		HCPL2731M	V <sub>CC</sub> = 4.5 V		0.12	0.4	
		6N139M	$I_F = 12 \text{ mA}, I_O = 24 \text{ mA},$ 0.1	0.18	0.4		
		HCPL2731M	V <sub>CC</sub> = 4.5 V		0.17	0.4	

#### Notes:

- Current Transfer Ratio is defined as a ratio of output collector current, I<sub>O</sub>, to the forward LED input current, I<sub>F</sub>, times 100%.
- 4. Pin 7 open. (6N138M and 6N139M only)

### **Electrical Characteristics** (Continued)

( $V_{CC}$  = 5.0 V,  $T_A$  = 0°C to 70°C unless otherwise specified. Typical value is measured at  $T_A$  = 25°C.)

### **Switching Characteristics**

Symbol	Parameter	Device	Test Conditions	Min.	Тур.	Max.	Unit
		6N139M	$R_L = 270 \Omega$ , $I_F = 12 \text{ mA}$		0.2	2	
		HCPL2730M, HCPL2731M	$R_L = 270 \Omega, I_F = 12 \text{ mA}$		0.5	3	
+	Propagation Delay Time to Logic	6N138M	$R_L = 2.2 \text{ k}\Omega, I_F = 1.6 \text{ mA}$		1.0	15	
t <sub>PHL</sub>	LOW <sup>(4)</sup> (Fig. 15)	HCPL2730M, HCPL2731M	$R_L = 2.2 \text{ k}\Omega, I_F = 1.6 \text{ mA}$		2.5	25	μs
		6N139M	$R_L = 4.7 \text{ k}\Omega, I_F = 0.5 \text{ mA}$		2.5	30	
		HCPL2731M	$R_L = 4.7 \text{ k}\Omega, I_F = 0.5 \text{ mA}$		8.4	120	
		6N139M	$R_L$ = 270 Ω, $I_F$ = 12 mA		1.3	10	
	Droposotion Dolov	HCPL2730M, HCPL2731M	$R_L$ = 270 Ω, $I_F$ = 12 mA		1.0	15	
t <sub>PLH</sub>	Propagation Delay Time to Logic HIGH <sup>(4)</sup> (Fig. 15)	6N138M, HCPL2730M, HCPL2731M	$R_L = 2.2 \text{ k}\Omega, I_F = 1.6 \text{ mA}$		7.3	50	μs
		6N139M, HCPL2731M	$R_L$ = 4.7 kΩ, $I_F$ = 0.5 mA		13.6	90	
CM <sub>H</sub>	Common Mode Transient Immunity at Logic High <sup>(5)</sup> (Fig. 16)	All	$I_F = 0 \text{ mA}, IV_{CM}I = 10 V_{P-P},$ $R_L = 2.2 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$	1,000	10,000		V/µs
CM <sub>L</sub>	Common Mode Transient Immunity at Logic Low <sup>(5)</sup> (Fig. 16)	All	$I_F$ = 1.6 mA, $IV_{CM}I$ = 10 $V_{P-P}$ , $R_L$ = 2.2 k $\Omega$ , $T_A$ = 25°C	1,000	10,000		V/µs

#### Note:

5. Common mode transient immunity in logic HIGH level is the maximum tolerable (positive) dV<sub>cm</sub>/dt on the leading edge of the common mode pulse signal V<sub>CM</sub>, to assure that the output will remain in a logic HIGH state (i.e., V<sub>O</sub> > 2.0 V). Common mode transient immunity in logic LOW level is the maximum tolerable (negative) dV<sub>cm</sub>/dt on the trailing edge of the common mode pulse signal, V<sub>CM</sub>, to assure that the output will remain in a logic LOW state (i.e., V<sub>O</sub> < 0.8 V).</p>

### **Electrical Characteristics** (Continued)

Isolation Characteristics (T<sub>A</sub> = 25°C unless otherwise specified.)

Symbol	Parameter	Device	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>ISO</sub>	Withstand Insulation Test Voltage <sup>(6)(7)</sup>	All	$RH \le 50\%$ , $T_A = 25^{\circ}C$ , $I_{I-O} \le 10 \ \mu A$ , $t = 1 \ min$ , $f = 50 \ Hz$	5,000			VAC <sub>RMS</sub>
R <sub>I-O</sub>	Resistance (Input to Output) <sup>(6)</sup>	All	V <sub>I-O</sub> = 500 V <sub>DC</sub>		10 <sup>11</sup>		Ω
C <sub>I-O</sub>	Capacitance (Input to Output) <sup>(6)(8)</sup>	All	f = 1 MHz, V <sub>I-O</sub> = 0 V		1		pF
I <sub>I-I</sub>	Input-Input Insulation Leakage Current <sup>(9)</sup>	HCPL2730M, HCPL2731M	$RH \le 45\%$ , $V_{I-I} = 500 V_{DC}$ , $t = 5 sec$		0.005		μA
R <sub>I-I</sub>	Input-Input Resistance <sup>(9)</sup>	HCPL2730M, HCPL2731M	V <sub>I-I</sub> = 500 V <sub>DC</sub>		10 <sup>11</sup>		Ω
C <sub>I-I</sub>	Input-Input Capacitance <sup>(9)</sup>	HCPL2730M, HCPL2731M	f = 1 MHz		0.03		pF

### Notes:

- 6. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.
- 7.  $5000 \text{ VAC}_{RMS}$  for 1 minute duration is equivalent to  $6000 \text{ VAC}_{RMS}$  for 1 second duration.
- 8. For dual channel devices, C<sub>I-O</sub> is measured by shorting pins 1 and 2 or pins 3 and 4 together and pins 5 through 8 shorted together.
- 9. Measured between pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

### **Electrical Characteristics** (Continued)

T<sub>A</sub> = 25°C unless otherwise specified

Current Limiting Resistor Calculations:

R<sub>1</sub> (Non-Invert) = 
$$V_{\underline{CC1}} - V_{\underline{DF}} - V_{\underline{OL1}}$$

$$R_1 \text{ (Invert)} = V_{CC1} - V_{OH1} - V_{DF}$$

$$R_2 = V_{CC2} - V_{OLX} (@ I_L - I_2)$$

#### Where:

V<sub>CC1</sub> = Input Supply Voltage

V<sub>CC2</sub> = Output Supply Voltage

V<sub>DF</sub> = Diode Forward Voltage

V<sub>OL1</sub> = Logic "0" Voltage of Driver

V<sub>OH1</sub> = Logic "1" Voltage of Driver

I<sub>F</sub> = Diode Forward Current

V<sub>OLX</sub> = Saturation Voltage of Output Transistor

I<sub>L</sub> = Load Current Through Resistor R<sub>2</sub>

I<sub>2</sub> = Input Current of Output Gate

INPUT			$R_2\left(\Omega\right)$ @ OUTPUT CONFIGURATION						
	URATION	R <sub>1</sub> (Ω)	CMOS @ 5 V	CMOS @ 10 V	74XX	74LXX	74SXX	74LSXX	74HXX
смоѕ	NON-INV.	2000							
@ 5 V	INV.	510							
смоѕ	NON-INV.	5100							
@ 10 V	INV.	4700							
- 4777	NON-INV.	2200							
74XX	INV.	180							
-41 2/2	NON-INV.	1800	4000	0000	750	4000	4000	4000	500
74LXX	INV.	100	1000	2200	750	1000	1000	1000	560
- 40VV	NON-INV.	2000							
74SXX	INV.	360							
741 000	NON-INV.	2000							
74LSXX	INV.	180							
741177	NON-INV.	2000							
74HXX	INV.	180							

Fig. 3 Resistor Values for Logic Interface

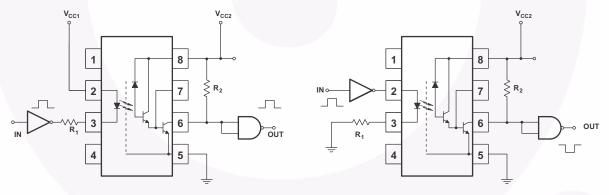


Fig. 4 Non-Inverting Logic Interface in 5 Inverting Logic in Fig. 5 Inverting Logic Interface

### **Typical Performance Curves**

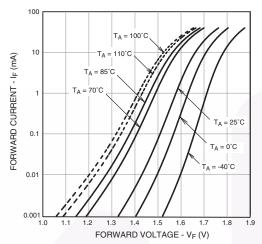


Fig. 6 LED Forward Current vs. Forward Voltage

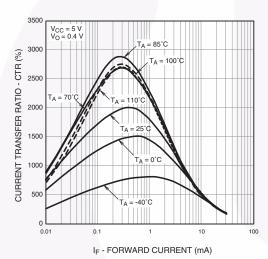


Fig. 8 Current Transfer Ratio vs. Forward Current (6N138M / 6N139M Only)

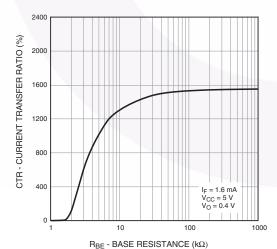


Fig. 10 Current Transfer Ratio vs. Base-Emitter Resistance (6N138M / 6N139M Only)

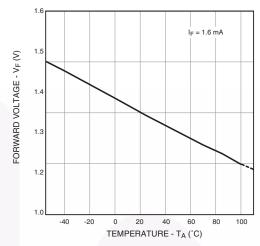


Fig. 7 LED Forward Voltage vs. Temperature

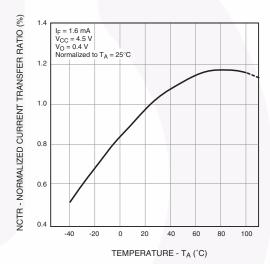


Fig. 9 Normalized Current Transfer Ratio vs. Ambient Temperature (6N138M / 6N139M Only)

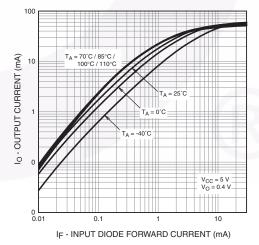


Fig. 11 Output Current vs. Input Diode Forward Current (6N138M / 6N139M Only)

# **Typical Performance Curves (Continued)**

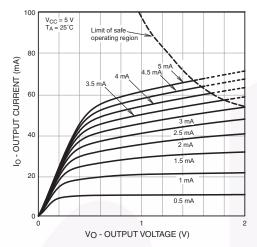


Fig. 12 Output Current vs Output Voltage (6N138M / 6N139M Only)

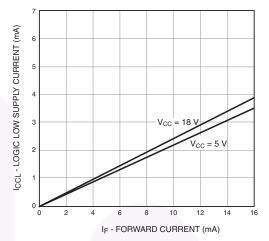


Fig. 13 Logic Low Supply Current vs. Input Diode Forward Current (6N138M / 6N139M Only)

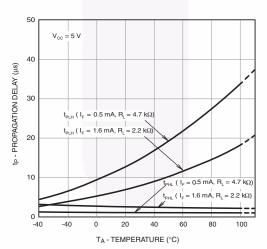


Fig. 14 Propagation Delay vs. Temperature (6N138M / 6N139M Only)

### **Test Circuits**

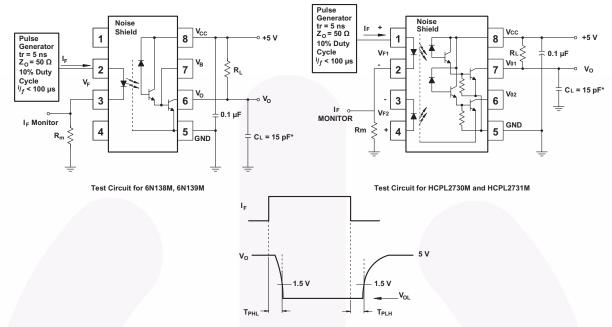


Fig. 15 Switching Time Test Circuit

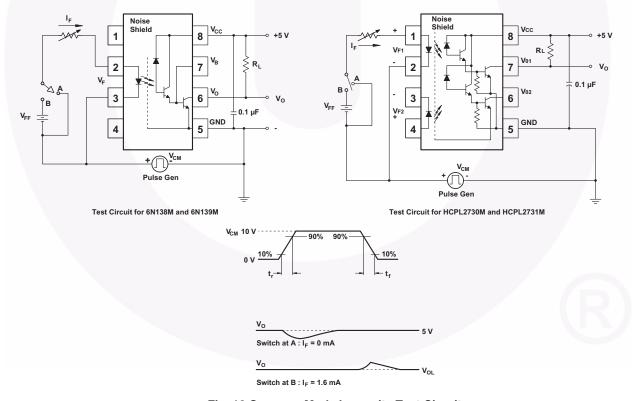
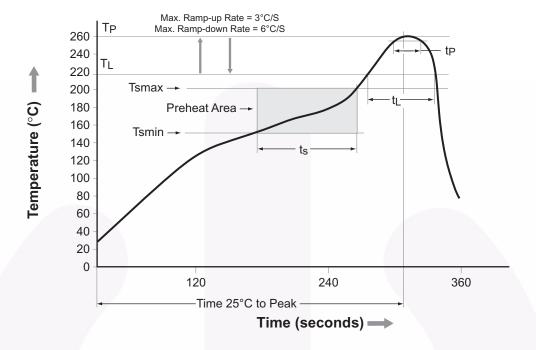


Fig. 16 Common Mode Immunity Test Circuit

### **Reflow Profile**



Profile Freature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t <sub>S</sub> ) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60-150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

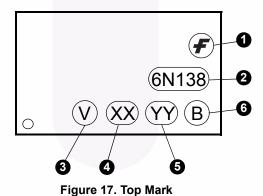
# **Ordering Information**

Part Number	Package	Packing Method
6N138M	DIP 8-Pin	Tube (50 units per tube)
6N138SM	SMT 8-Pin (Lead Bend)	Tube (50 units per tube)
6N138SDM	SMT 8-Pin (Lead Bend)	Tape and Reel (1,000 units per reel)
6N138VM	DIP 8-Pin, DIN EN/IEC 60747-5-5 Option	Tube (50 units per tube)
6N138SVM	SMT 8-Pin (Lead Bend), DIN EN/IEC 60747-5-5 Option	Tube (50 units per tube)
6N138SDVM	SMT 8-Pin (Lead Bend), DIN EN/IEC 60747-5-5 Option	Tape and Reel (1,000 units per reel)
6N138TVM	DIP 8-Pin, 0.4" Lead Spacing, DIN EN/IEC 60747-5-5 Option	Tube (50 units per tube)
6N138TSVM	SMT 8-Pin, 0.4" Lead Spacing, DIN EN/IEC 60747-5-5 Option	Tube (50 units per tube)
6N138TSR2VM	SMT 8-Pin, 0.4" Lead Spacing, DIN EN/IEC 60747-5-5 Option	Tape and Reel (1,000 units per reel)

#### Note:

The product orderable part number system listed in this table also applies to the 6N139M, HCPL2730M and HCPL2731M product families.

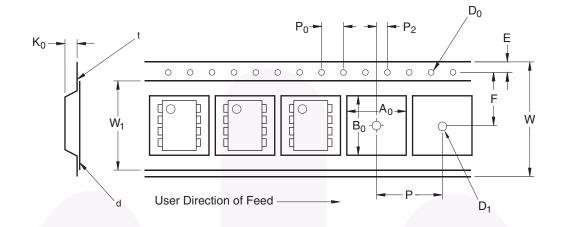
# **Marking Information**



Definitions

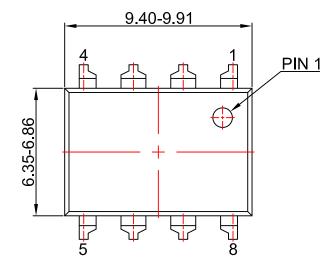
1 Fairchild Logo
2 Device Number
3 DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)
4 Two Digit Year Code, e.g., '16'
5 Two Digit Work Week Ranging from '01' to '53'
6 Assembly Package Code

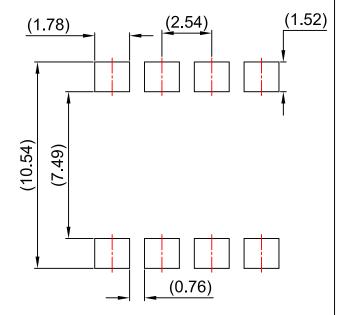
# **Carrier Tape Specifications (Option SD)**

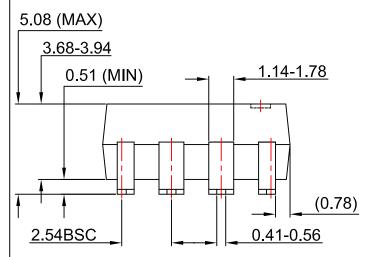


Symbol	Description	Dimension in mm
W	Tape Width	16.0 ± 0.3
t	Tape Thickness	$0.30 \pm 0.05$
P <sub>0</sub>	Sprocket Hole Pitch	4.0 ± 0.1
D <sub>0</sub>	Sprocket Hole Diameter	1.55 ± 0.05
Е	Sprocket Hole Location	1.75 ± 0.10
F	Pocket Location	7.5 ± 0.1
P <sub>2</sub>		2.0 ± 0.1
Р	Pocket Pitch	12.0 ± 0.1
A <sub>0</sub>	Pocket Dimensions	10.30 ±0.20
B <sub>0</sub>		10.30 ±0.20
K <sub>0</sub>		4.90 ±0.20
W <sub>1</sub>	Cover Tape Width	13.2 ± 0.2
d	Cover Tape Thickness	0.1 max
	Max. Component Rotation or Tilt	10°
R	Min. Bending Radius	30

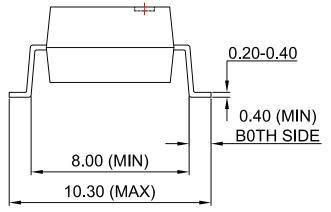








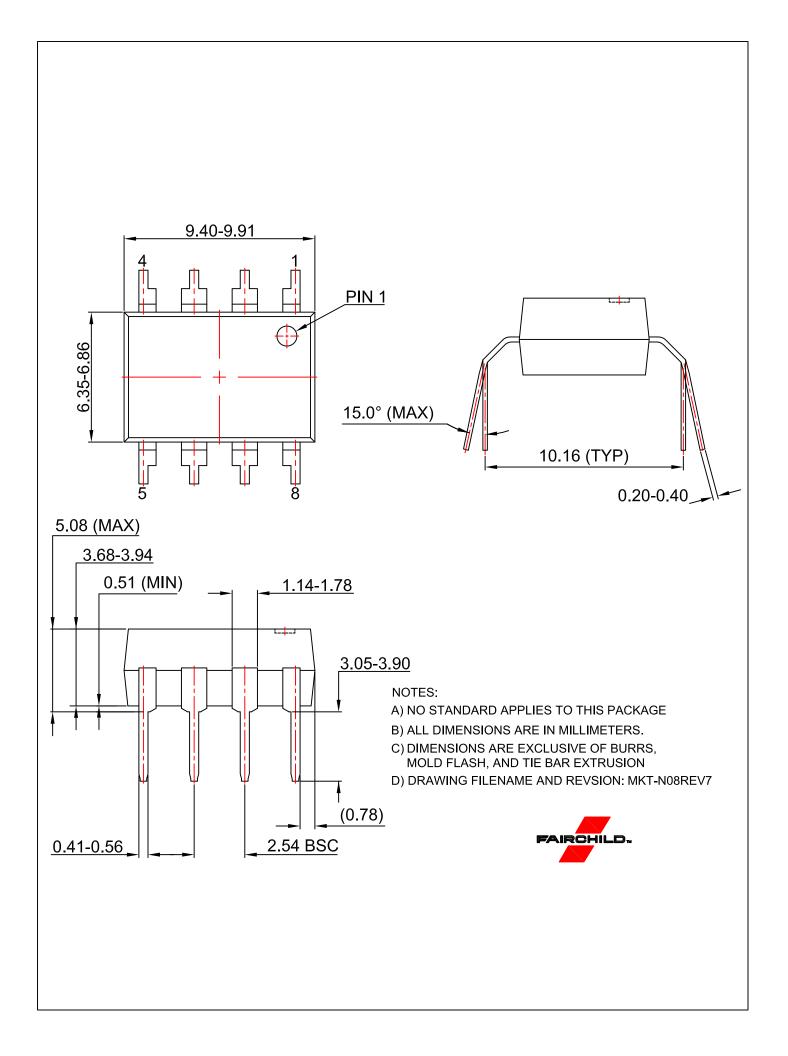




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